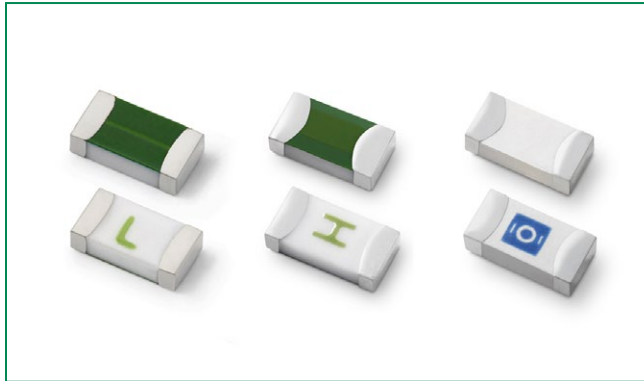


437A Series – 1206 Fast-Acting Ceramic Fuse



Agency Approvals

Agency	Agency File Number	Ampere Range
	E10480	0.500A – 8A
	29862	0.500A – 8A

Electrical Characteristics for Series

% of Ampere Rating	Ampere Rating	Opening Time at 25°C
100%	0.500A – 8A	4 hours, Minimum
250%	0.750A – 8A	5 seconds, Maximum
350%	0.750A – 8A	1 second, Maximum
	0.500A	5 seconds, Maximum

Description

The 437A Series AECQ-Compliant fuses are specifically tested to cater to secondary circuit protection needs of compact auto-electronics applications.

The general design ensures excellent temperature stability and performance reliability. In addition to this, the high I²t values typical of the Littelfuse Ceramic Fuse family ensure high inrush current withstand capability.

Features

- Operating Temperature from -55°C to +150°C
- 100% Lead-free, Halogen-Free and RoHS compliant
- Meets Littelfuse's automotive qualifications*
- Fast response to faulty current to ensure over-current protection for sensitive electronic components

* - Largely based on Littelfuse internal AEC-Q200 test plan.

Applications

- Li-ion Battery
- LED Lighting
- Automotive Navigation System
- TFT Display
- Battery Management System (BMS)
- Clusters

Additional Information



Datasheet





Resources



Samples

Electrical Specifications by Item

Ampere Rating (A)	Amp Code	Max. Voltage Rating (V)	Interrupting Rating ¹	Nominal Resistance (Ohms) ²	Nominal Melting I ² t (A ² Sec.) ³	Nominal Voltage Drop At Rated Current (V) ⁴	Nominal Power Dissipation At Rated Current (W)	Agency Approvals	
									
0.500	.500	63	50A @ 63VAC/DC	0.908	0.018	0.52	0.260	x	x
0.750	.750	63	50A @ 63VAC/DC 100A @ 63VDC	0.600	0.064	0.45	0.338	x	x
1.00	001.	63	50A @ 63VAC/DC	0.420	0.100	0.41	0.410	x	x
1.25	1.25	63		0.318	0.256	0.40	0.500	x	x
1.50	01.5	63		0.209	0.324	0.39	0.585	x	x
1.75	1.75	63		0.071	0.075	0.27	0.473	x	x
2.00	002.	63		0.062	0.144	0.20	0.400	x	x
2.50	02.5	32		50A @ 32VAC/35VDC	0.043	0.441	0.15	0.375	x
3.00	003.	32	0.035		0.506	0.14	0.420	x	x
3.50	03.5	32	0.027		0.777	0.13	0.455	x	x
4.00	004.	32	0.022		1.024	0.13	0.520	x	x
5.00	005.	32	0.0159		2.30	0.13	0.650	x	x
7.00	007.	32	0.0100		5.02	0.13	0.910	x	x
8.00	008.	32	0.008		7.23	0.13	1.040	x	x

Notes:

1. AC Interrupting Rating tested at rated voltage with unity power factor. DC Interrupting Rating tested at rated voltage with time constant < 0.8 msec.
2. Nominal Resistance measured with < 10% rated current.
3. Nominal Melting I²t measured at 1 msec. opening time.
4. Nominal Voltage Drop measured at rated current after temperature has stabilized.

Devices designed to carry rated current for 4 hours minimum. It is recommended that devices be operated continuously at no more than 80% rated current. See "Temperature Re-rating Curve" for additional re-rating information. Devices designed to be mounted with marking code facing up.

Temperature Re-rating Curve



Note:

1. Re-rating depicted in this curve is in addition to the standard re-rating of 20% for continuous operation.
Example:
For continuous operation at 75 degrees celsius, the fuse should be rerated as follows:
 $I = (0.80)(0.85)I_{RAT} = (0.68)I_{RAT}$

Part Numbering System



Average Time Current Curves



Soldering Parameters

Reflow Condition		Pb-free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (Min to Max) (t_s)	60 – 180 seconds
Average Ramp-up Rate (Liquidus Temp (T_L) to peak)		5°C/second max.
$T_{s(max)}$ to T_L - Ramp-up Rate		5°C/second max.
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5°C/second max.
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C
Wave Soldering		260°C, 10 seconds max.

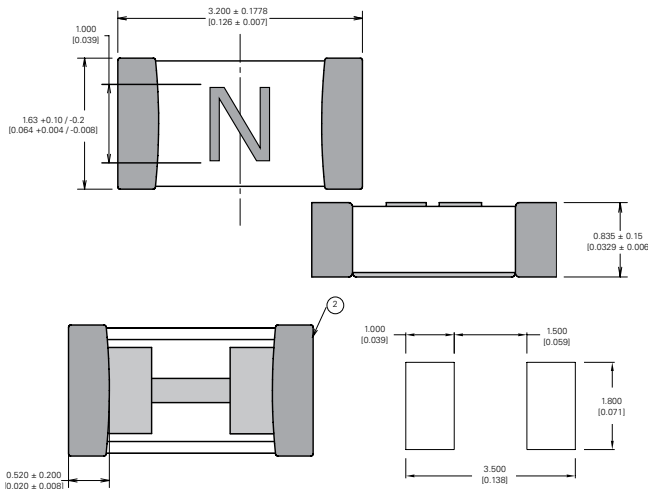


Product Characteristics

Materials	Body: Advanced Ceramic Terminations: Ag/Ni/Sn (100% Lead-free) Element Cover Coating: Lead-free Glass
Moisture Sensitivity Level	IPC/JEDEC J-STD-020, Level 1
Solderability	IPC/EIC/JEDEC J-STD-002, Condition B
Humidity Test	MIL-STD-202, Method 103, Conditions D
Resistance to Solder Heat	MIL-STD-202, Method 210, Condition B
Moisture Resistance	MIL-STD-202, Method 106
Thermal Shock	MIL-STD-202, Method 107, Condition B
Mechanical Shock	MIL-STD-202, Method 213, Condition A
Vibration	MIL-STD-202, Method 201
Vibration, High Frequency	MIL-STD-202, Method 204, Condition D
Dissolution of Metallization	IPC/EIC/JEDEC J-STD-002, Condition D
Terminal Strength	IEC 60127-4

High Temperature Storage	MIL-STD-202 Method 108 with exemptions
Thermal Shock Test	JESD22 Method JA-104, Test Conditions B and N
Biased Humidity	MIL-STD-202 Method 103, 85°C/85% RH with 10% operating power for 1000 hrs
Operational Life	MIL-STD-202 Method 108, Test Condition D
Resistance To Solvents	MIL-STD-202 Method 215
Mechanical Shock	MIL-STD-202 Method 213, Test Condition C
High Frequency Vibration	MIL-STD-202, Method 204
Resistance To Soldering Heat	MIL-STD-202 Method 210, Test Condition B
Solderability	JESD22-B102E Method 1
Terminal Strength For SMD	AEC Q200-006
Board Flex	AEC Q200-005
Electrical Characterization	3 Temperature Electrical Characterization

Dimensions



Part Marking System

Amp Code	Marking Code
.500	F
.750	G
001.	H
1.25	J
01.5	K
1.75	L
002.	N
02.5	Q
003.	P
3.500	R
004.	S
005.	T
007.	W
008.	 X

Packaging

Packaging Option	Packaging Specification	Quantity	Quantity and Packaging Code
8mm Tape and Reel	EIA-481, IEC 60286, Part 3	3000	WRA

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<http://moschip.ru/get-element>

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